# PATENT COOPERATION TREATY

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# **PCT**

## INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference							
216	FOR FURTHER ACTION	Examination Report (Form PCT/IPEA/416)					
International application No.	International filing date (day/mont.	h/year) Priority Date (day/month/year)					
PCT/KR 2004/001092	12 May 2004 (12.05.2004						
International Patent Classification (IPC) or na	tional classification and IPC						
IPC8: H01L 21/312 (2006.01); C09D 183/06 (2006.01)							
Applicant SOGANG UNIVERSITY CORPORATION							
This international preliminary exa and is transmitted to the applicant	This international preliminary examination report has been prepared by this International Preliminary Examination Authority and is transmitted to the applicant according to Article 36.						
2. This REPORT consists of a total of 3 sheets, including this cover sheet.							
This report is also accompanied by ANNEXES, i.e., sheets of the description, claims and/or drawings which have beer amended and are the basis for this report and/or sheets containing rectifications made before this Authority (see Rule 70.16 and Section 607 of the Administrative Instructions under the PCT).							
These annexes consist of a total of sheets.							
<ol><li>This report contains indications rel</li></ol>	ating to the following items:						
I. Basis of the opinion							
II. Priority							
	III. Non-establishment of opinion with regard to novelty, inventive step and industrial applicability						
IV. Lack of unity of	invention						
V. Reasoned statement under Rule 66.2(a)(ii) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement							
VI. Certain documen	VI. Certain documents cited						
VII. Certain defects in	VII. Certain defects in the international application						
VIII. Certain observations on the international application							
Date of submission of the demand		Date of completion of this report					
28 June 2005 (28.0	6.2005)	14 March 2006 (14.03.2006)					
Name and mailing address of the IPEA/A	T Author	ized officer					
Austrian Patent Office Dresdner Straße 87	ł	HARASEK S.					
A-1200 Vienna		TIMINACEN O.					
Facsimile No. 1/53424/200		one No. 1/53424/574					
orm PCT/IPE A /409 (cover sheet) (July 1009)							

Form PCT/IPEA/409 (cover sheet) (July 1998)

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## -INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No. PCT/KR 2004/001092

1.		Basis of the report
1.	Wit	h regard to the elements of the international application:*
	Ц	the international application as originally filed
	$\boxtimes$	the description:
		pages 2-15, as originally filed
		pages 1, filed with the demand
	_	pages, filed with the letter of
	$\boxtimes$	the claims:
		pages 16, 17, as originally filed
		pages, as amended (together with any statement) under Article 19 pages, filed with the demand
		pages, filed with the letter of
	X	the drawings:
	لكيا	pages 1, as originally filed
		pages, filed with the demand
		pages, filed with the letter of
		the sequence listing part of the description:
		pages, as originally filed
		pages, filed with the demand
		pages, filed with the letter of
2.	With	regard to the language, all the elements marked above were available or furnished to this Authority in the language in
	Thes	ch the international application was filed, unless otherwise indicated under this item.  se elements were available or furnished to this Authority in the following language English which is:
		·
		the language of a translation furnished for the purposes of international search (under Rule 23.1(b)).
		the language of publication of the international application (under Rule 48.3(b)).  the language of the translation furnished for the purposes of international preliminary examination (under Rule 55.2 and/
_	*****	or 55.3).
3.	preli	n regard to any nucleotide and/or amino acid sequence disclosed in the international application, the international iminary examination was carried out on the basis of the sequence listing:
		contained in the international application in printed form.
		filed together with the international application in computer readable form.
	므	furnished subsequently to this Authority in written form.
		furnished subsequently to this Authority in computer readable form.
		The statement that the subsequently furnished written sequence listing does not go beyond the disclosure in the international application as filed has been furnished.
		The statement that the information recorded in computer readable form is identical to the written sequence listing has been furnished.
4.		The amendments have resulted in the cancellation of:
		the description, pages
	•	the claims, Nos
		the drawings, sheets/fig
5.		This report has been established as if (some of) the amendments had not been made, since they have been considered to go beyond the disclosure as filed, as indicated in the Supplemental Box (Rule 70.2(c)).**
1	n this . 70.17).	
**,	Any rep	placement sheet containing such amendments must be referred to under item 1 and annexed to this report.

International application No.

INTERNATIONAL PRELI	PCT/KR 2004/001092		
V. Reasoned statement under Art citations and explanations sup	icle 35(2)	with regard to novelty, inventive step	or industrial applicability;
1. Statement			<del></del>
Novelty (N)	Claims	1-7	YES
	Claims		NO
Inventive step (IS)	Claims	1-7	YES
	Claims		NO
Industrial applicability (IA)	Claims	1-7	YES
	Claims		NO
D1: JP 2000328004 A D2: JP 8143818 A D3: US 6204202 B1 D4: JP 5315319 A		en cited in the International So	
claims, neither taken ald	ne no	r in combination. Therefore	technical features of the present e, based on the results of the lered to be novel and involving an
		ternational Search Report I	has not been established by this Authority.
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## ULTRA-LOW DIELECTRICS FILM FOR COPPER INTERCONNECT

### **BACKGROUND OF THE INVENTION**

## FIELD OF THE INVENTION

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The present invention relates to an ultra-low dielectric film for a copper interconnect, in particular, to an porous film prepared by coating with an organic solution containing a polyalkyl silsesquioxane precursor or its copolymer as a matrix and acetylcyclodextrin nanoparticles as a template and followed by performing a sol-gel reaction and heat treatment at higher temperature. The present films may contain the template of up to 60 vol%, which is due to the selective use of acetylcyclodextrin, and have homogeneously distributed pores with the size of no more than 5 nm in the matrix. In addition, the present films exhibit an ultra low dielectric constant of about 1.5, and well-defined closed pores, so that thus being considered as a good ultra-low dielectric film for a copper interconnect.

### DESCRIPTION OF THE RELATED ART

Due to the recent request for semiconductors to have the properties of high integration and high speed, the critical dimension is on the drastic decrease. Low dielectrics, fabricated with aluminum liner and silicone oxide membrane ( $SiO_2$ , k=4.0) and fluoro-silicone oxide membrane (k=3.5) as interlayer dielectrics, have been recognized as an excellent semiconductor device having high integration and high performance. However, such low dielectrics show serious shortcomings that signal delay due to delay of RC [expressed as multiplying a resistance (R) of a liner